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Substitute Form PTO-1449 (Modified)	U.S. Department of Commerce Patent and Trademark Office	Attorney's Docket No. 10559-584002	Application No.		
by A	closure Statement pplicant	Applicant Chris E. Barns et al.			
(Use several si	neets if necessary)	Filing Date March 12, 2004	Group Art Unit		

U.S. Patent Documents							
Examiner Initial	Desig.	Document Number	Publication Date	Patentee	Class	Subclass	Filing Date . If Appropriate
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•	Other D	ocuments (include Author, Title, Date, and Place of Publication)
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LV	ÁC	Ducroquet et al., "Full CMP Integration," IEEE Transactions on Electron Devices, 48(8):1816-1821, 2001
	AD	Matsuda et al., "Performance Improvement of Metal," Symposium on VLSI Technology Digest of Technical Papers, 2001
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	AH	Conaghan et al., "Applications of silicides in semiconductor processing," (No PATE)
	Al	Abstract, Cabot Microelectronics Corporation, Semiconductor Products, 2000
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